## Product Preview

# SWITCHMODE Power Rectifier 150 V, 20 A

#### **Features and Benefits**

- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capability
- 20 A Total (10 A Per Diode Leg)
- Guard-Ring for Stress Protection
- This is a Pb-Free Device

#### **Applications**

- Power Supply Output Rectification
- Power Management
- Instrumentation

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight (Approximately): 1.9 Grams (TO-220 & TO-220FP)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

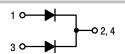
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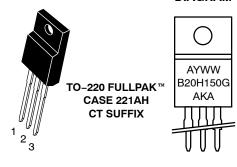
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## SCHOTTKY BARRIER RECTIFIER 20 AMPERES, 150 VOLTS



#### MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week B20H150 = Device Code G = Pb-Free Device AKA = Polarity Designator

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### MAXIMUM RATINGS (Per Diode Leg)

Rating		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	150	V
Average Rectified Forward Current (Per Leg) (Rated $V_R$ ) $T_C = 134$ °C (Per Device)	I <sub>F(AV)</sub>	10 20	Α
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	180	Α
Operating Junction Temperature (Note 1)	TJ	-20 to +150	°C
Storage Temperature	T <sub>stg</sub>	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs
ESD Ratings: Machine Model = C Human Body Model = 3B		> 400 > 8000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Maximum Thermal Resistance  – Junction-to-Case  – Junction-to-Ambient	$egin{array}{l} R_{ hetaJC} \ R_{ hetaJA} \end{array}$	3.6 105	°C/W

## **ELECTRICAL CHARACTERISTICS** (Per Diode Leg)

Rating	Symbol	Тур	Max	Unit
$\label{eq:maximum Instantaneous Forward Voltage (Note 2)} \begin{array}{c} (I_F=5~A,~T_C=25^{\circ}C)\\ (I_F=5~A,~T_C=125^{\circ}C)\\ (I_F=10~A,~T_C=25^{\circ}C)\\ (I_F=10~A,~T_C=125^{\circ}C) \end{array}$	VF	0.72 0.57 0.87 0.65	0.60 0.68	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C$ = 25°C) (Rated DC Voltage, $T_C$ = 125°C)	i <sub>R</sub>		50 30	μA mA

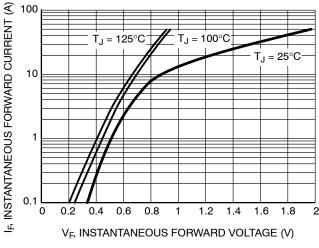
<sup>2.</sup> Pulse Test: Pulse Width = 300  $\mu s, \, Duty \, Cycle \leq 2.0\%.$ 

#### **DEVICE ORDERING INFORMATION**

Device Order Number	Package Type	Shipping <sup>†</sup>
MBRJ20H150CTG	TO-220FP (Pb-Free)	50 Units / Rail

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

<sup>1.</sup> The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .





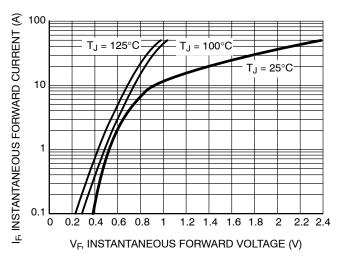


Figure 2. Maximum Forward Voltage

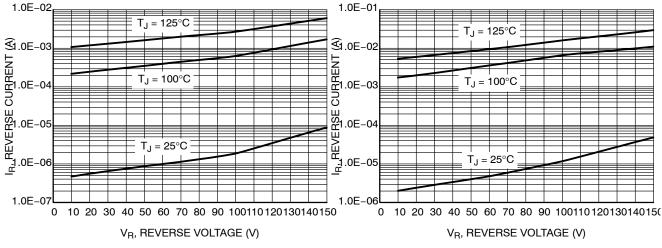


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

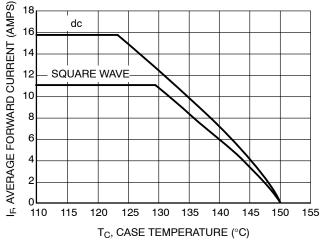


Figure 5. Current Derating

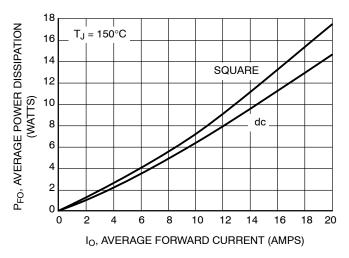


Figure 6. Forward Power Dissipation

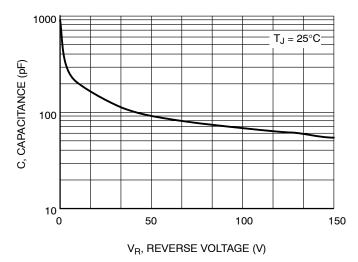


Figure 7. Capacitance

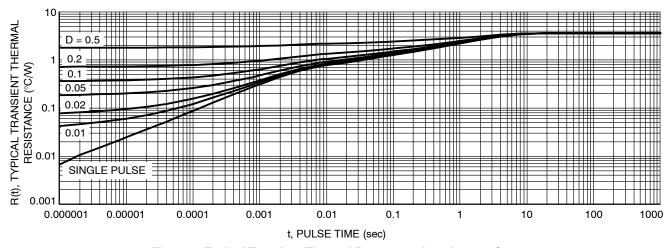
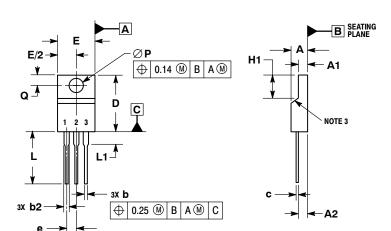


Figure 8. Typical Transient Thermal Response, Junction-to-Case

#### PACKAGE DIMENSIONS

#### TO-220 FULLPACK, 3-LEAD CASE 221AH ISSUE C



#### NOTES

- DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. CONTOUR UNCONTROLLED IN THIS AREA.
  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE TO BE MEASURED AT OUTERMOST EXTREME OF THE PLASTIC BODY.
  DIMENSION b2 DOES NOT INCLUDE DAMBAR
- PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.00.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.30	4.70	
A1	2.50	2.90	
A2	2.50	2.70	
b	0.54	0.84	
b2	1.10	1.40	
С	0.49	0.79	
D	14.70	15.30	
Е	9.70	10.30	
е	2.54 BSC		
H1	6.70	7.10	
L	12.70	14.73	
L1		2.80	
P	3.00	3.40	
Q	2.80	3.20	

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